



The **DCS3-030318** piezoelectric stack consists of multiple chips which are bonded via epoxy. It offers a maximum displacement of 19.8  $\mu$ m. The red wire of the electrode serves as the positive terminal (+), and the black wire is the negative terminal (-).



### DCS3-030318

Drive Voltage Range	-30~150 V	Capacitance	530nF ± 15%
Displacement (Free Stroke) at 150 V	19.8 μm ± 15%	Dissipation Factor	<2.3%
Hysteresis	<15%	<b>Resonant Frequency</b>	65kHZ
Stiffness	19 N/µm	Blocking Force at 150 V	360N
Curie Temperature	230 °C	Operating Temperature	-25 ~ 130 °C
Product Size	L: 3.0mm	Outer Dimensions	L: $3.4 \pm 0.2$ mm
	W: 3.0mm		W: $4.9 \pm 0.2 mm$
	H: 18.8mm		H: 18.8± 0.1mm

### **Performance Parameters**

• All specifications are quoted at 25°C, unless otherwise stated.

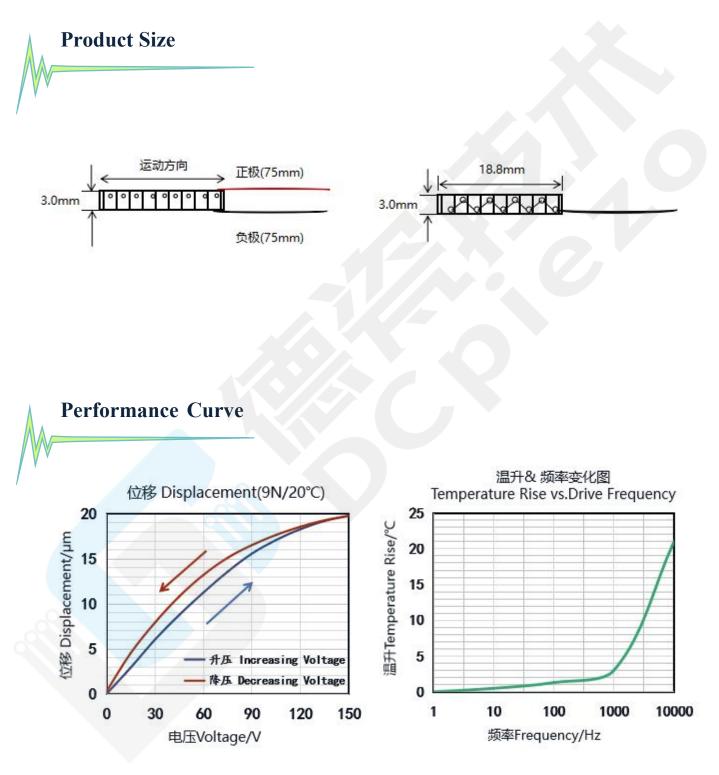
• The displacement may vary slightly for different loads, and the maximum displacement

occurs when used with the recommended load.

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• These temperature rises were measured after applying a sine-wave drive voltage ranging from 0 to 150V at the specified frequency for 10 minutes.

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### **Matters Needing Attention**

#### 1. Storage Conditions & Precautions:

Temperature: <50 °C, Humidity: <40%Rh. Avoid impact and compression. Store in vacuum-sealed bags for long-term preservation. When not in use, connect to a resistive discharge ( $\geq$ 100k $\Omega$ ) or short-circuit (for low-capacitance ceramics).

#### 2. Operating Conditions & Precautions:

Temperature: Maximum operating temperature  $\leq 130^{\circ}$ C (preferably  $< 60^{\circ}$ C). Add heat dissipation measures if temperature exceeds  $80^{\circ}$ C.

Humidity: <50%Rh. In high-humidity environments, preheat at low voltage before use to avoid creepage discharge.

Dust Avoidance: Dust adhesion on ceramic surfaces may reduce insulation resistance.

Clearance: Maintain a gap >1.6mm between ceramics and other conductors.

Safety: Do not immerse piezoelectric stacks in organic solvents or expose to flammable gases/liquids.

#### 3. Assembly Precautions:

Polarity: Red wire = positive (+), black wire = negative (-). Reverse polarity may cause mechanical failure.

Handling: Handle with care to avoid impact. Wear gloves to prevent oil contamination.

Fit Tolerance: Assemble with clearance fit first, then tighten. Avoid interference fit to prevent ceramic compression.

Electrostatic Protection: Maintain >1.6mm gap between ceramics and metal parts to avoid static discharge.

Adhesive Bonding: Ensure flat bonding surfaces and remove excess glue to minimize contamination. Soldering: Limit contact time under high temperature to <1 second to protect ceramics and coatings.

High-Temperature Assembly: Control temperature <120  $^{\circ}$ C to prevent depolarization, adhesive failure, or coating damage.

#### 4. Preload Instructions:

Load Application: Apply external load to the center of the stack or distribute uniformly on the Guangdong DCpiezo Technology Co., Ltd.

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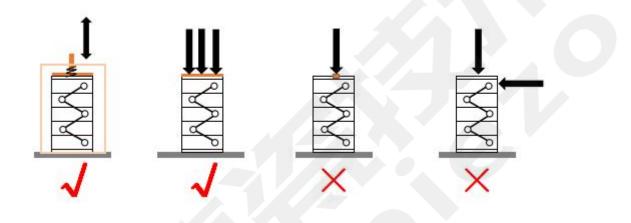




mounting surface. Ensure contact surfaces are flat and smooth.

Force Direction: Piezoelectric stacks can only withstand axial forces. Shear or torsional forces may cause mechanical failure.

Preload Force: Preload should not exceed 40% of maximum blocking force, and its direction must align with the motion axis to minimize shear stress.



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